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General Information

Series	KONNEKT Auto U2J
Style	KONNEKT
Description	SMD, MLCC, KONNEKT, Ultra-Stable, Class I
Features	High Density Packaging
RoHS	Yes
Termination	Tin
Qualifications	AEC-Q200
AEC-Q200	Yes
Chip Size	1210-2
Shelf Life	78 Weeks
MSL	1

Dimensions

L	3.2mm +/-0.20mm
W	2.5mm +/-0.20mm
T	3.4mm +/-0.4mm
B	0.5mm +/-0.25mm

Packaging Specifications

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	375

Specifications

Capacitance	0.36 uF
Tolerance	10%
Voltage DC	100 VDC
Dielectric Withstanding Voltage	250 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	U2J
Dissipation Factor	0.1% 1 kHz 25C
Aging Rate	0.1% Loss/Decade Hour
Insulation Resistance	2.7778 GOhms

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